

OCT 25 2004

**In re Application of**

**TI-31484**

**Examiner: Matthew E. Warren**

**Art Unit 2815**

**For: Thermal Coupling of Matched SOI Device Bodies**

## NOTICE OF APPEAL FROM THE PRIMARY EXAMINER TO THE BOARD OF APPEALS

I hereby certify that the above correspondence is being transmitted by facsimile to the U.S. Patent and Trademark Office at 703-872-9306 on the date shown below:

Karen Vortz  
Karen Vortz

10-25-04  
Date

Sir:

Applicant hereby appeals claims 6-13 and 15-19 to the Board of Appeals from the decision dated July 26, 2004 of the Primary Examiner finally rejecting claims 6-13 and 15-19.

**The item(s) checked below are appropriate:**


1.        An extension of time to respond to the final rejection  
       was granted on       .  
       is requested for        month(s).
2.   X   A timely response to the final rejection has been filed, as provided in 841 O.G. 1411.
3.   X   Fee \$340.00:

10/28/2004 AJONES3-00000000 Not required (Fee paid in prior appeal)

01 FC:1401      X  
340.00      The Commissioner of Patents is hereby authorized to charge any fees which may be required, or credit any overpayment to Deposit Account No. 20-0668 of Texas Instruments Incorporated.

**Signature [Rule 191(b)]** \_\_\_\_\_

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